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# STTH200L04TV1

### Ultrafast high voltage rectifier

### Features

- Ultrafast switching
- Low reverse current
- Low thermal resistance
- Reduces switching and conduction losses
- Package insulation voltage: 2500 V<sub>RMS</sub>

### Description

The STTH200L04TV1 uses ST 400 V technology and is specially suited for use in switching power supplies, welding equipment, and industrial applications, as an output rectification diode.

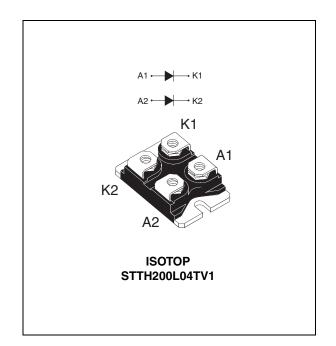


Table 1.Device summary

Symbol	Value
I <sub>F(AV)</sub>	up to 2 x 120 A
V <sub>RRM</sub>	400 V
T <sub>j</sub> (max)	150 °C
V <sub>F</sub> (typ)	0.83 V
t <sub>rr</sub> (max)	50 ns

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### 1 Characteristics

Symbol	Param	Value	Unit			
V <sub>RRM</sub>	Repetitive peak reverse voltage	Repetitive peak reverse voltage			V	
I <sub>F(RMS)</sub>	Forward rms current			200	А	
	Average forward ourrept	$T_c = 90 \ ^{\circ}C \ \delta = 0.5$	Per diode	100	А	
IF(AV)	Average forward current	$T_c = 73 \text{ °C } \delta = 0.5$			A	
I <sub>FSM</sub>	Surge non repetitive forward $t_p = 10 \text{ ms sinusoidal}$			900	A	
T <sub>stg</sub>	Storage temperature range			-55 to + 150	°C	
Тj	Maximum operating junction temperature			150	°C	

### Table 2. Absolute ratings (limiting values, per diode)

#### Table 3.Thermal resistance

Symbol	Parameter	Value (max).	Unit	
D	Junction to case Per dio	de	0.50	
R <sub>th(j-c)</sub>	Total		0.30	°C/W
R <sub>th(c)</sub>	Coupling		0.10	

When diodes 1 and 2 are used simultaneously:

 $\Delta$  Tj(diode 1) = P(diode 1) x R<sub>th(j-c)</sub>(Per diode) + P(diode 2) x R<sub>th(c)</sub>

#### Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I <sub>B</sub> <sup>(1)</sup>	Reverse leakage	T <sub>j</sub> = 25 °C	V - V			100	
'R`	'R`´ current	T <sub>j</sub> = 125 °C	V <sub>R</sub> = V <sub>RRM</sub>		100	1000	μA
V <sub>F</sub> <sup>(2)</sup>	Forward voltage drop	T <sub>j</sub> = 25 °C	I <sub>F</sub> = 100 A			1.2	V
VF Forward voltage	Forward voltage drop	T <sub>j</sub> = 150 °C	F = 100 A		0.83	1.0	v

1. Pulse test:  $t_p = 5 \text{ ms}, \delta < 2\%$ 

2. Pulse test:  $t_p$  = 380 µs,  $\delta$  < 2%

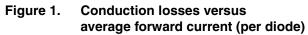
To evaluate the conduction losses use the following equation: P = 0.8 x  $I_{F(AV)}$  + 0.002  $I_{F}{}^{2}_{(RMS)}$ 





Symbol	Parameter		Min.	Тур.	Max.	Unit	
+	Reverse recovery	T <sub>i</sub> = 25 °C	$    I_F = 1 \ A  dI_F/dt = 50 \ A/\mu s \\ V_R = 30 \ V $		75	100	ns
t <sub>rr</sub>	time	1 <sub>j</sub> =25 C	$I_F = 1 A dI_F/dt = 200 A/\mu s$ $V_R = 30 V$		45	60	115
I <sub>RM</sub>	Reverse recovery current	T <sub>j</sub> = 125 °C	I <sub>F</sub> = 100 A V <sub>R</sub> = 200 V dI <sub>F</sub> /dt = 100 A/μs			18	А
S <sub>factor</sub>	Softness factor	T <sub>j</sub> = 125 °C	$I_F = 100 A$ $V_R = 200 V$ $dI_F/dt = 100 A/\mu s$		0.4		
t <sub>fr</sub>	Forward recovery time	T <sub>j</sub> = 25 °C	$    I_F = 100 \text{ A} \qquad dI_F/dt = 200 \text{ A}/\mu\text{s} \\ V_{FR} = 1.1 \text{ x} \text{ V}_{Fmax} $			800	ns
$V_{FP}$	Forward recovery voltage	T <sub>j</sub> = 25 °C	$I_F = 100 \text{ A}  dI_F/dt = 200 \text{ A}/\mu\text{s}$ $V_{FR} = 1.1 \text{ x} \text{ V}_{Fmax}$		2.6		V

 Table 5.
 Dynamic characteristics (per diode)



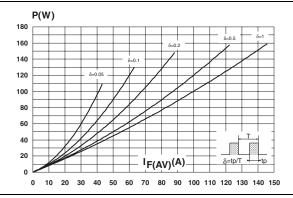
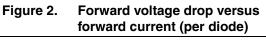


Figure 3. Relative variation of thermal impedance junction to case versus pulse duration

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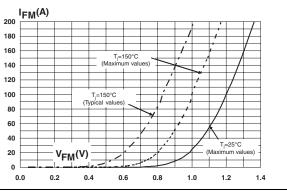
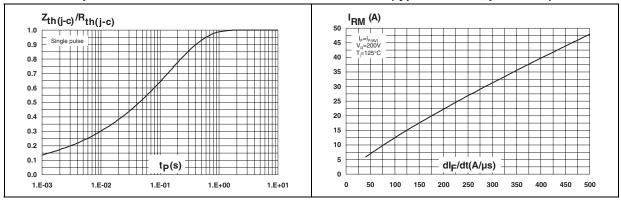
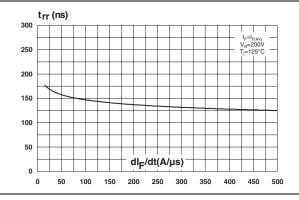
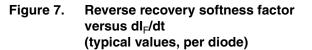


Figure 4. Peak reverse recovery current versus dl<sub>F</sub>/dt (typical values, per diode)



# Figure 5. Reverse recovery time versus $dI_F/dt$ (typical values, per diode)

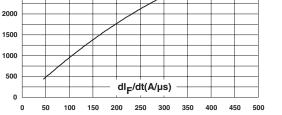


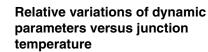




**Reverse recovery charges versus** 

dl<sub>F</sub>/dt (typical values, per diode)





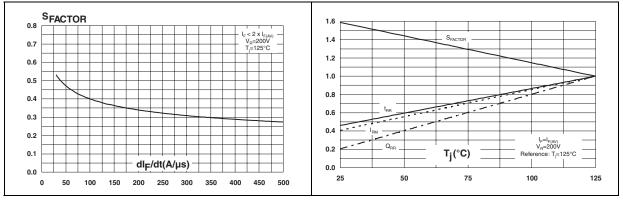


Figure 6.

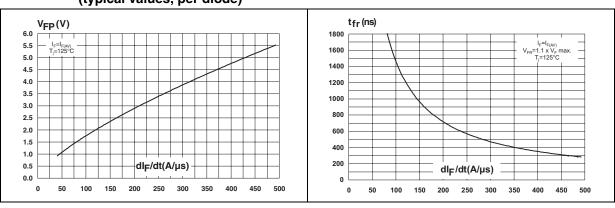
3500

Figure 8.

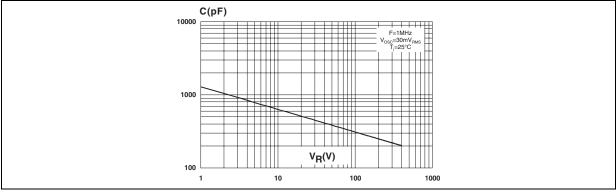
Q<sub>rr</sub> (nC)

# Figure 9. Transient peak forward voltage versus dl<sub>F</sub>/dt (typical values, per diode)

# Figure 10. Forward recovery time versus dl<sub>F</sub>/dt (typical values, per diode)







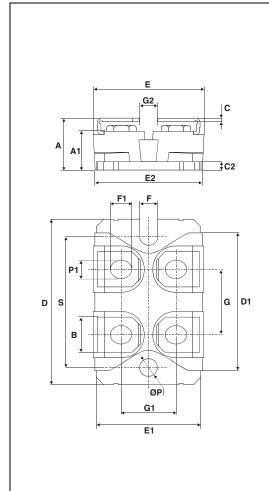


### 2 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: <u>www.st.com</u>. ECOPACK<sup>®</sup> is an ST trademark.

Table 6. ISOTOP dimensions



	Dimensions					
Ref.	Millim	neters	Inc	hes		
	Min.	Max.	Min.	Max.		
А	11.80	12.20	0.465	0.480		
A1	8.90	9.10	0.350	0.358		
В	7.8	8.20	0.307	0.323		
С	0.75	0.85	0.030	0.033		
C2	1.95	2.05	0.077	0.081		
D	37.80	38.20	1.488	1.504		
D1	31.50	31.70	1.240	1.248		
Е	25.15	25.50	0.990	1.004		
E1	23.85	24.15	0.939	0.951		
E2	24.80	0 typ.	0.97	6 typ.		
G	14.90	15.10	0.587	0.594		
G1	12.60	12.80	0.496	0.504		
G2	3.50	4.30	0.138	0.169		
F	4.10	4.30	0.161	0.169		
F1	4.60	5.00	0.181	0.197		
Р	4.00	4.30	0.157	0.69		
P1	4.00	4.40	0.157	0.173		
S	30.10	30.30	1.185	1.193		



## **3** Ordering information

### Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty	Delivery mode
STTH200L04TV1	STTH200L04TV1	ISOTOP	27 g (without screws)	10 (with screws)	Tube

## 4 Revision history

#### Table 8.Document revision history

Date	Revision	Changes
11-Aug-2006	1	First issue.
05-Sep-2011	2	Changed value of R <sub>d</sub> to 0.002 in the conduction losses equation above <i>Table 4</i> . Reformatted to current standards.



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